



## Material Content Data Sheet



<b>Sales Product Name</b>		BTS7008-2EPA		<b>Issued</b>		4. July 2019		
<b>MA#</b>		MA005340532						
<b>Package</b>		PG-TSDSO-14-22		<b>Weight*</b>		65.41 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.479	2.26	2.26	22603	22603
leadframe	inorganic material	phosphorus	7723-14-0	0.009	0.01		144	
	non noble metal	zinc	7440-66-6	0.038	0.06		576	
	non noble metal	iron	7439-89-6	0.754	1.15		11527	
wire	non noble metal	copper	7440-50-8	30.617	46.81	48.03	468050	480297
	non noble metal	copper	7440-50-8	0.924	1.41	1.41	14133	14133
	encapsulation	organic material	carbon black	1333-86-4	0.086	0.13		1314
plastics	plastics	epoxy resin	-	3.353	5.13		51260	
	inorganic material	silicondioxide	60676-86-0	25.220	38.55	43.81	385547	438121
	leadfinish	non noble metal	tin	7440-31-5	1.642	2.51	2.51	25096
plating	noble metal	silver	7440-22-4	0.816	1.25	1.25	12475	12475
glue	plastics	epoxy resin	-	0.083	0.13		1273	
	noble metal	silver	7440-22-4	0.393	0.60	0.73	6002	7275
*deviation	< 10%					Sum in total:	100.00	1000000

### Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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